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Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	I ² C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	36
Program Memory Size	28KB (16K x 14)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 28x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	40-DIP (0.600", 15.24mm)
Supplier Device Package	40-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lf1519-i-p

PIC16(L)F1516/7/8/9

TABLE 1: 28/40/44-PIN ALLOCATION TABLE

I/O	28-Pin SPDIP, SOIC, SSOP	28-Pin QFN, UQFN	40-Pin PDIP	40-Pin UQFN	44-Pin TQFP	ADC	Timers	CCP	EUSART	MSSP	Interrupt	Pull-up	Basic
RA0	2	27	2	17	19	AN0	—	—	—	SS ⁽²⁾	—	—	—
RA1	3	28	3	18	20	AN1	—	—	—	—	—	—	—
RA2	4	1	4	19	21	AN2	—	—	—	—	—	—	—
RA3	5	2	5	20	22	AN3/VREF+	—	—	—	—	—	—	—
RA4	6	3	6	21	23	—	T0CKI	—	—	—	—	—	—
RA5	7	4	7	22	24	AN4	—	—	—	SS ⁽¹⁾	—	—	VCAP
RA6	10	7	14	29	31	—	—	—	—	—	—	—	OSC2/CLKOUT
RA7	9	6	13	28	30	—	—	—	—	—	—	—	OSC1/CLKIN
RB0	21	18	33	8	8	AN12	—	—	—	—	INT/IOC	Y	—
RB1	22	19	34	9	9	AN10	—	—	—	—	IOC	Y	—
RB2	23	20	35	10	10	AN8	—	—	—	—	IOC	Y	—
RB3	24	21	36	11	11	AN9	—	CCP2 ⁽²⁾	—	—	IOC	Y	—
RB4	25	22	37	12	14	AN11	—	—	—	—	IOC	Y	—
RB5	26	23	38	13	15	AN13	T1G	—	—	—	IOC	Y	—
RB6	27	24	39	14	16	—	—	—	—	—	IOC	Y	ICSPCLK/ICDCLK
RB7	28	25	40	15	17	—	—	—	—	—	IOC	Y	ICSPDAT/ICDDAT
RC0	11	8	15	30	32	—	SOSCO/T1CKI	—	—	—	—	—	—
RC1	12	9	16	31	35	—	SOSCI	CCP2 ⁽¹⁾	—	—	—	—	—
RC2	13	10	17	32	36	AN14	—	CCP1	—	—	—	—	—
RC3	14	11	18	33	37	AN15	—	—	—	SCK/SCL	—	—	—
RC4	15	12	23	38	42	AN16	—	—	—	SDI/SDA	—	—	—
RC5	16	13	24	39	43	AN17	—	—	—	SDO	—	—	—
RC6	17	14	25	40	44	AN18	—	—	TX/CK	—	—	—	—
RC7	18	15	26	1	1	AN19	—	—	RX/DT	—	—	—	—
RD0 ⁽³⁾	—	—	19	34	38	AN20	—	—	—	—	—	—	—
RD1 ⁽³⁾	—	—	20	35	39	AN21	—	—	—	—	—	—	—
RD2 ⁽³⁾	—	—	21	36	40	AN22	—	—	—	—	—	—	—
RD3 ⁽³⁾	—	—	22	37	41	AN23	—	—	—	—	—	—	—
RD4 ⁽³⁾	—	—	27	2	2	AN24	—	—	—	—	—	—	—
RD5 ⁽³⁾	—	—	28	3	3	AN25	—	—	—	—	—	—	—
RD6 ⁽³⁾	—	—	29	4	4	AN26	—	—	—	—	—	—	—
RD7 ⁽³⁾	—	—	30	5	5	AN27	—	—	—	—	—	—	—
RE0 ⁽³⁾	—	—	8	23	25	AN5	—	—	—	—	—	—	—
RE1 ⁽³⁾	—	—	9	24	26	AN6	—	—	—	—	—	—	—
RE2 ⁽³⁾	—	—	10	25	27	AN7	—	—	—	—	—	—	—
RE3	1	26	1	16	18	—	—	—	—	—	—	Y	MCLR/VPP
VDD	20	17	11, 32	7, 26	7, 28	—	—	—	—	—	—	—	—
VSS	8, 19	5, 16	12, 31	6, 27	6, 29	—	—	—	—	—	—	—	—
NC	—	—	—	—	12, 13, 33, 34	—	—	—	—	—	—	—	—

Note 1: Peripheral pin location selected using APFCON register. Default location.

Note 2: Peripheral pin location selected using APFCON register. Alternate location.

Note 3: PIC16(L)F1517/9 only.

3.2.1 READING PROGRAM MEMORY AS DATA

There are two methods of accessing constants in program memory. The first method is to use tables of RETLW instructions. The second method is to set an FSR to point to the program memory.

3.2.1.1 RETLW Instruction

The RETLW instruction can be used to provide access to tables of constants. The recommended way to create such a table is shown in Example 3-1.

EXAMPLE 3-1: RETLW INSTRUCTION

```
constants
    BRW          ;Add Index in W to
                  ;program counter to
                  ;select data
    RETLW DATA0 ;Index0 data
    RETLW DATA1 ;Index1 data
    RETLW DATA2
    RETLW DATA3

my_function
    ;... LOTS OF CODE...
    MOVLW DATA_INDEX
    CALL constants
    ;... THE CONSTANT IS IN W
```

The BRW instruction makes this type of table very simple to implement. If the code must remain portable with previous generations of microcontrollers, then the BRW instruction is not available so the older table read method must be used.

3.2.1.2 Indirect Read with FSR

The program memory can be accessed as data by setting bit 7 of the FSRxH register and reading the matching INDFx register. The MOVIW instruction will place the lower eight bits of the addressed word in the W register. Writes to the program memory cannot be performed via the INDF registers. Instructions that access the program memory via the FSR require one extra instruction cycle to complete. Example 3-2 demonstrates accessing the program memory via an FSR.

The HIGH directive will set bit<7> if a label points to a location in program memory.

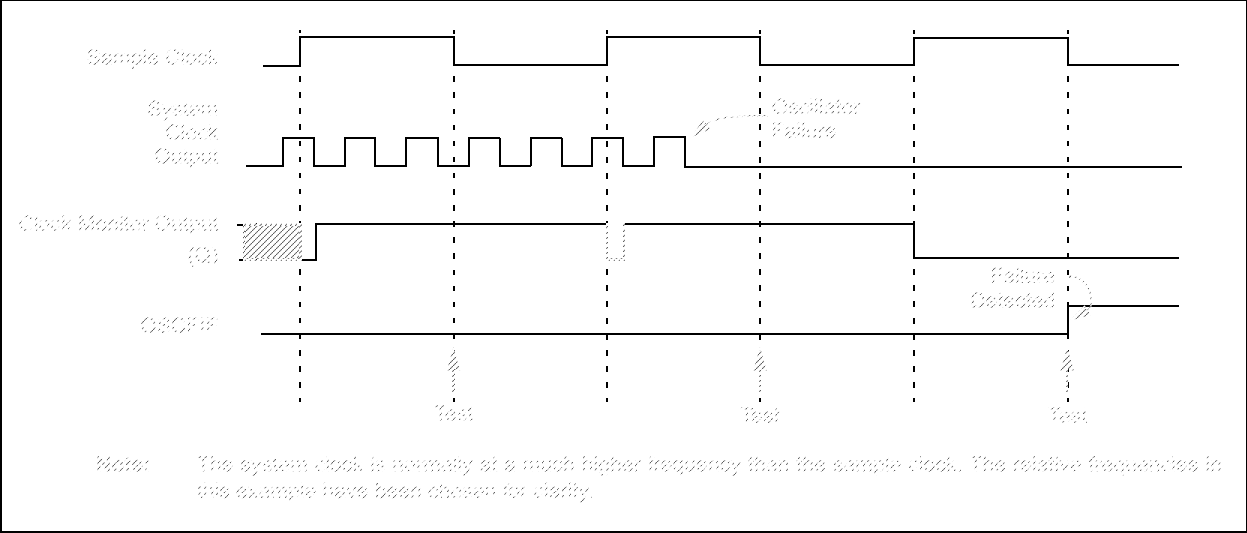
EXAMPLE 3-2: ACCESSING PROGRAM MEMORY VIA FSR

```
constants
    DW DATA0      ;First constants
    DW DATA1      ;Second constant
    DW DATA2      ;
    DW DATA3      ;

my_function
    ;... LOTS OF CODE...
    MOVLW DATA_INDEX
    MOVWF LOW constants
    MOVWF FSR1H
    MOVLW HIGH constants ;MSB is set
                          ;automatically
    MOVWF FSR1H
    BTFSC STATUS,C      ;carry from ADDLW?
    INCF FSR1H,f         ;yes
    MOVIW 0[FSR1]
    ;THE PROGRAM MEMORY IS IN W
```

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FIGURE 5-10: FSCM TIMING DIAGRAM



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REGISTER 5-2: OSCSTAT: OSCILLATOR STATUS REGISTER

R-1/q	U-0	R-q/q	R-0/q	U-0	U-0	R-0/q	R-0/q
SOSCR	—	OSTS	HFIOFR	—	—	LFIOFR	HFIOFS
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
u = Bit is unchanged x = Bit is unknown -n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set '0' = Bit is cleared q = Conditional

- bit 7 **SOSCR:** Secondary Oscillator Ready bit
If T1OSCEN = 1:
1 = Secondary oscillator is ready
0 = Secondary oscillator is not ready
If T1OSCEN = 0:
1 = Timer1 clock source is always ready
- bit 6 **Unimplemented:** Read as '0'
- bit 5 **OSTS:** Oscillator Start-up Timer Status bit
1 = Running from the clock defined by the FOSC<2:0> bits of the Configuration Words
0 = Running from an internal oscillator (FOSC<2:0> = 100)
- bit 4 **HFIOFR:** High Frequency Internal Oscillator Ready bit
1 = HFINTOSC is ready
0 = HFINTOSC is not ready
- bit 3-2 **Unimplemented:** Read as '0'
- bit 1 **LFIOFR:** Low Frequency Internal Oscillator Ready bit
1 = LFINTOSC is ready
0 = LFINTOSC is not ready
- bit 0 **HFIOFS:** High Frequency Internal Oscillator Stable bit
1 = HFINTOSC 16 MHz Oscillator is stable and is driving the INTOSC
0 = HFINTOSC 16 MHz is not stable, the Start-up Oscillator is driving INTOSC

TABLE 5-2: SUMMARY OF REGISTERS ASSOCIATED WITH CLOCK SOURCES

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
OSCCON	—	IRCF<3:0>				—	SCS<1:0>		59
OSCSTAT	SOSCR	—	OSTS	HFIOFR	—	—	LFIOFR	HFIOFS	60
PIE2	OSFIE	—	—	—	BCLIE	—	—	CCP2IE	76
PIR2	OSFIF	—	—	—	BCLIF	—	—	CCP2IF	78
T1CON	TMR1CS<1:0>		T1CKPS<1:0>		T1OSCEN	T1SYNC	—	TMR1ON	155

Legend: — = unimplemented location, read as '0'. Shaded cells are not used by clock sources.

TABLE 5-3: SUMMARY OF CONFIGURATION WORD WITH CLOCK SOURCES

Name	Bits	Bit -7	Bit -6	Bit 13/5	Bit 12/4	Bit 11/3	Bit 10/2	Bit 9/1	Bit 8/0	Register on Page
CONFIG1	13:8			FCMEN	IESO	CLKOUTEN	BOREN<1:0>		—	42
	7:0	CP	MCLRE	PWRTE	WDTE<1:0>		FOSC<2:0>			

Legend: — = unimplemented location, read as '0'. Shaded cells are not used by clock sources.

REGISTER 7-4: PIR1: PERIPHERAL INTERRUPT REQUEST REGISTER 1

R/W-0/0	R/W-0/0	R-0/0	R-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
TMR1GIF	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

u = Bit is unchanged

x = Bit is unknown

-n/n = Value at POR and BOR/Value at all other Resets

'1' = Bit is set

'0' = Bit is cleared

bit 7 **TMR1GIF:** Timer1 Gate Interrupt Flag bit

1 = Interrupt is pending

0 = Interrupt is not pending

bit 6 **ADIF:** ADC Interrupt Flag bit

1 = Interrupt is pending

0 = Interrupt is not pending

bit 5 **RCIF:** USART Receive Interrupt Flag bit

1 = Interrupt is pending

0 = Interrupt is not pending

bit 4 **TXIF:** USART Transmit Interrupt Flag bit

1 = Interrupt is pending

0 = Interrupt is not pending

bit 3 **SSPIF:** Synchronous Serial Port (MSSP) Interrupt Flag bit

1 = Interrupt is pending

0 = Interrupt is not pending

bit 2 **CCP1IF:** CCP1 Interrupt Flag bit

1 = Interrupt is pending

0 = Interrupt is not pending

bit 1 **TMR2IF:** Timer2 to PR2 Interrupt Flag bit

1 = Interrupt is pending

0 = Interrupt is not pending

bit 0 **TMR1IF:** Timer1 Overflow Interrupt Flag bit

1 = Interrupt is pending

0 = Interrupt is not pending

Note: Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the Global Enable bit, GIE, of the INTCON register. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

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11.2.4 WRITING TO FLASH PROGRAM MEMORY

Program memory is programmed using the following steps:

1. Load the address in PMADRH:PMADRL of the row to be programmed.
2. Load each write latch with data.
3. Initiate a programming operation.
4. Repeat steps 1 through 3 until all data is written.

Before writing to program memory, the word(s) to be written must be erased or previously unwritten. Program memory can only be erased one row at a time. No automatic erase occurs upon the initiation of the write.

Program memory can be written one or more words at a time. The maximum number of words written at one time is equal to the number of write latches. See Figure 11-5 (row writes to program memory with 32 write latches) for more details.

The write latches are aligned to the Flash row address boundary defined by the upper ten bits of PMADRH:PMADRL, (PMADRH<6:0>:PMADRL<7:5>) with the lower five bits of PMADRL, (PMADRL<4:0>) determining the write latch being loaded. Write operations do not cross these boundaries. At the completion of a program memory write operation, the data in the write latches is reset to contain 0x3FFF.

The following steps should be completed to load the write latches and program a row of program memory. These steps are divided into two parts. First, each write latch is loaded with data from the PMDATH:PMDATL using the unlock sequence with LWLO = 1. When the last word to be loaded into the write latch is ready, the LWLO bit is cleared and the unlock sequence executed. This initiates the programming operation, writing all the latches into Flash program memory.

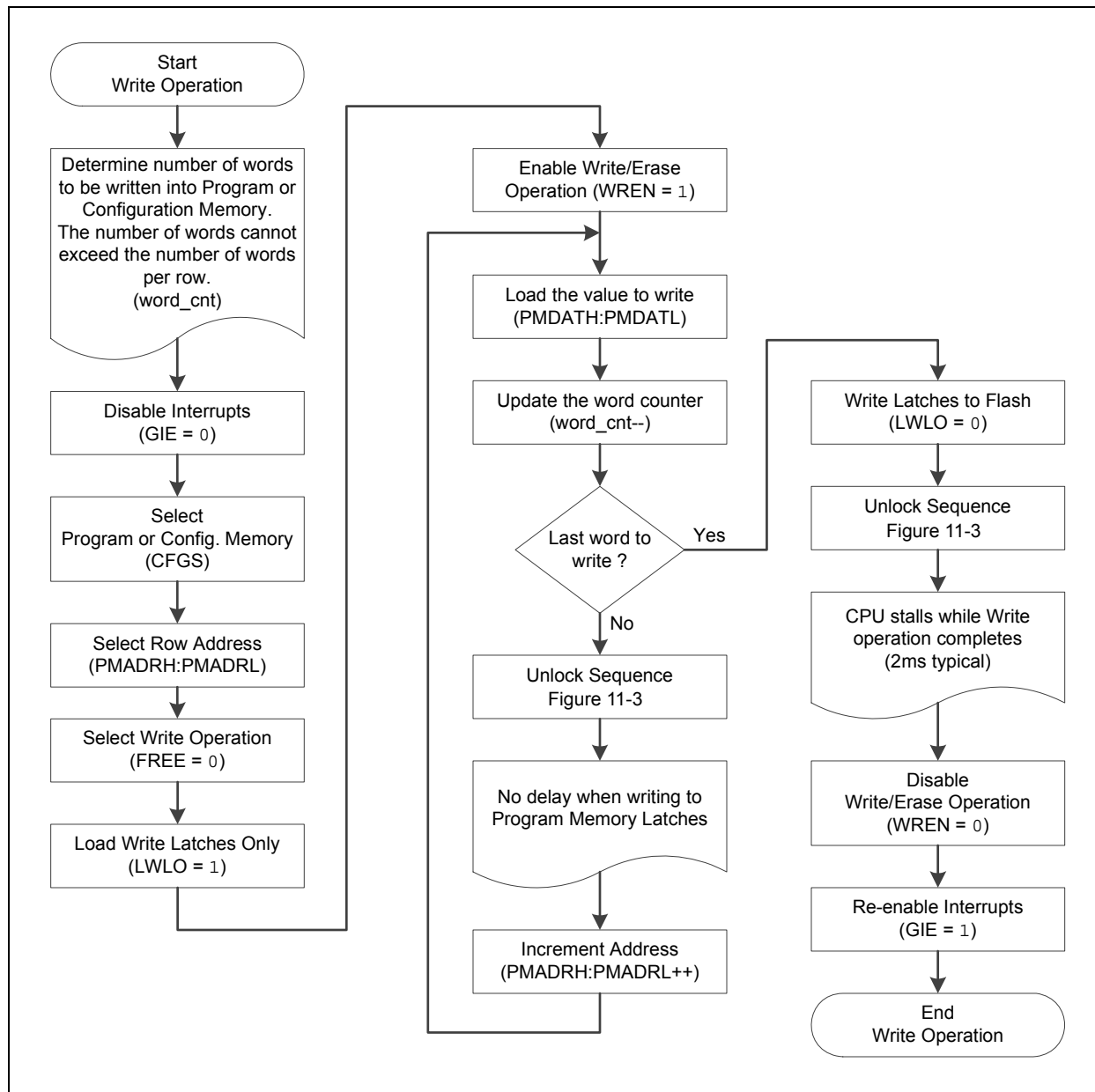
Note: The special unlock sequence is required to load a write latch with data or initiate a Flash programming operation. If the unlock sequence is interrupted, writing to the latches or program memory will not be initiated.

1. Set the WREN bit of the PMCON1 register.
2. Clear the CFGS bit of the PMCON1 register.
3. Set the LWLO bit of the PMCON1 register. When the LWLO bit of the PMCON1 register is '1', the write sequence will only load the write latches and will not initiate the write to Flash program memory.
4. Load the PMADRH:PMADRL register pair with the address of the location to be written.
5. Load the PMDATH:PMDATL register pair with the program memory data to be written.
6. Execute the unlock sequence (**Section 11.2.2 "Flash Memory Unlock Sequence"**). The write latch is now loaded.
7. Increment the PMADRH:PMADRL register pair to point to the next location.
8. Repeat steps 5 through 7 until all but the last write latch has been loaded.
9. Clear the LWLO bit of the PMCON1 register. When the LWLO bit of the PMCON1 register is '0', the write sequence will initiate the write to Flash program memory.
10. Load the PMDATH:PMDATL register pair with the program memory data to be written.
11. Execute the unlock sequence (**Section 11.2.2 "Flash Memory Unlock Sequence"**). The entire program memory latch content is now written to Flash program memory.

Note: The program memory write latches are reset to the blank state (0x3FFF) at the completion of every write or erase operation. As a result, it is not necessary to load all the program memory write latches. Unloaded latches will remain in the blank state.

An example of the complete write sequence is shown in Example 11-3. The initial address is loaded into the PMADRH:PMADRL register pair; the data is loaded using indirect addressing.

FIGURE 11-6: FLASH PROGRAM MEMORY WRITE FLOWCHART



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REGISTER 11-6: PMCON1: PROGRAM MEMORY CONTROL 1 REGISTER

U-1	R/W-0/0	R/W-0/0	R/W/HC-0/0	R/W/HC-x/q ⁽²⁾	R/W-0/0	R/S/HC-0/0	R/S/HC-0/0
— ⁽¹⁾	CFGFS	LWLO	FREE	WRERR	WREN	WR	RD
bit 7							bit 0

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
S = Bit can only be set	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	HC = Bit is cleared by hardware

- bit 7 **Unimplemented:** Read as '1'
- bit 6 **CFGFS:** Configuration Select bit
1 = Access Configuration, User ID and Device ID Registers
0 = Access Flash program memory
- bit 5 **LWLO:** Load Write Latches Only bit⁽³⁾
1 = Only the addressed program memory write latch is loaded/updated on the next WR command
0 = The addressed program memory write latch is loaded/updated and a write of all program memory write latches will be initiated on the next WR command
- bit 4 **FREE:** Program Flash Erase Enable bit
1 = Performs an erase operation on the next WR command (hardware cleared upon completion)
0 = Performs an write operation on the next WR command
- bit 3 **WRERR:** Program/Erase Error Flag bit
1 = Condition indicates an improper program or erase sequence attempt or termination (bit is set automatically on any set attempt (write '1') of the WR bit).
0 = The program or erase operation completed normally.
- bit 2 **WREN:** Program/Erase Enable bit
1 = Allows program/erase cycles
0 = Inhibits programming/erasing of program Flash
- bit 1 **WR:** Write Control bit
1 = Initiates a program Flash program/erase operation.
The operation is self-timed and the bit is cleared by hardware once operation is complete.
The WR bit can only be set (not cleared) in software.
0 = Program/erase operation to the Flash is complete and inactive.
- bit 0 **RD:** Read Control bit
1 = Initiates a program Flash read. Read takes one cycle. RD is cleared in hardware. The RD bit can only be set (not cleared) in software.
0 = Does not initiate a program Flash read.

- Note** 1: Unimplemented bit, read as '1'.
2: The WRERR bit is automatically set by hardware when a program memory write or erase operation is started (WR = 1).
3: The LWLO bit is ignored during a program memory erase operation (FREE = 1).

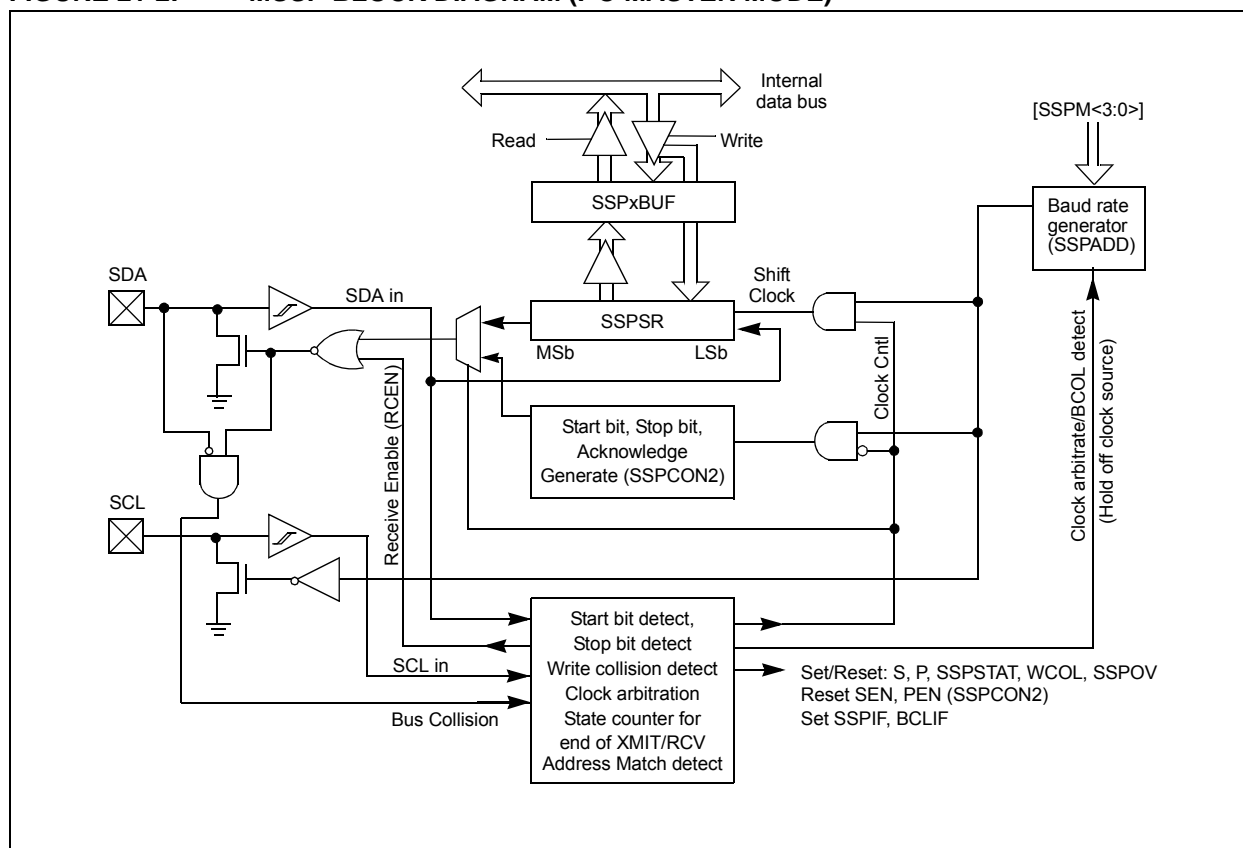
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The I²C interface supports the following modes and features:

- Master mode
- Slave mode
- Byte NACKing (Slave mode)
- Limited Multi-master support
- 7-bit and 10-bit addressing
- Start and Stop interrupts
- Interrupt masking
- Clock stretching
- Bus collision detection
- General call address matching
- Address masking
- Address Hold and Data Hold modes
- Selectable SDA hold times

Figure 21-2 is a block diagram of the I²C interface module in Master mode. Figure 21-3 is a diagram of the I²C interface module in Slave mode.

FIGURE 21-2: MSSP BLOCK DIAGRAM (I²C MASTER MODE)



21.5.3.3 7-bit Transmission with Address Hold Enabled

Setting the AHEN bit of the SSPCON3 register enables additional clock stretching and interrupt generation after the 8th falling edge of a received matching address. Once a matching address has been clocked in, CKP is cleared and the SSPIF interrupt is set.

Figure 21-19 displays a standard waveform of a 7-bit Address Slave Transmission with AHEN enabled.

1. Bus starts Idle.
2. Master sends Start condition; the S bit of SSPSTAT is set; SSPIF is set if interrupt on Start detect is enabled.
3. Master sends matching address with $\overline{R/W}$ bit set. After the 8th falling edge of the SCL line the CKP bit is cleared and SSPIF interrupt is generated.
4. Slave software clears SSPIF.
5. Slave software reads ACKTIM bit of SSPCON3 register, and $\overline{R/W}$ and D/A of the SSPSTAT register to determine the source of the interrupt.
6. Slave reads the address value from the SSPBUF register clearing the BF bit.
7. Slave software decides from this information if it wishes to ACK or not ACK and sets the ACKDT bit of the SSPCON2 register accordingly.
8. Slave sets the CKP bit releasing SCL.
9. Master clocks in the \overline{ACK} value from the slave.
10. Slave hardware automatically clears the CKP bit and sets SSPIF after the ACK if the $\overline{R/W}$ bit is set.
11. Slave software clears SSPIF.
12. Slave loads value to transmit to the master into SSPBUF setting the BF bit.

Note: SSPBUF cannot be loaded until after the \overline{ACK} .

13. Slave sets the CKP bit, releasing the clock.
14. Master clocks out the data from the slave and sends an ACK value on the 9th SCL pulse.
15. Slave hardware copies the \overline{ACK} value into the ACKSTAT bit of the SSPCON2 register.
16. Steps 10-15 are repeated for each byte transmitted to the master from the slave.
17. If the master sends a not \overline{ACK} the slave releases the bus allowing the master to send a Stop and end the communication.

Note: Master must send a not \overline{ACK} on the last byte to ensure that the slave releases the SCL line to receive a Stop.

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21.6.10 SLEEP OPERATION

While in Sleep mode, the I²C slave module can receive addresses or data and when an address match or complete byte transfer occurs, wake the processor from Sleep (if the MSSP interrupt is enabled).

21.6.11 EFFECTS OF A RESET

A Reset disables the MSSP module and terminates the current transfer.

21.6.12 MULTI-MASTER MODE

In Multi-Master mode, the interrupt generation on the detection of the Start and Stop conditions allows the determination of when the bus is free. The Stop (P) and Start (S) bits are cleared from a Reset or when the MSSP module is disabled. Control of the I²C bus may be taken when the P bit of the SSPSTAT register is set, or the bus is Idle, with both the S and P bits clear. When the bus is busy, enabling the SSP interrupt will generate the interrupt when the Stop condition occurs.

In multi-master operation, the SDA line must be monitored for arbitration to see if the signal level is the expected output level. This check is performed by hardware with the result placed in the BCLIF bit.

The states where arbitration can be lost are:

- Address Transfer
- Data Transfer
- A Start Condition
- A Repeated Start Condition
- An Acknowledge Condition

21.6.13 MULTI-MASTER COMMUNICATION, BUS COLLISION AND BUS ARBITRATION

Multi-Master mode support is achieved by bus arbitration. When the master outputs address/data bits onto the SDA pin, arbitration takes place when the master outputs a '1' on SDA, by letting SDA float high and another master asserts a '0'. When the SCL pin floats high, data should be stable. If the expected data on SDA is a '1' and the data sampled on the SDA pin is '0', then a bus collision has taken place. The master will set the Bus Collision Interrupt Flag, BCLIF and reset the I²C port to its Idle state (Figure 21-32).

If a transmit was in progress when the bus collision occurred, the transmission is halted, the BF flag is cleared, the SDA and SCL lines are deasserted and the SSPBUF can be written to. When the user services the bus collision Interrupt Service Routine and if the I²C bus is free, the user can resume communication by asserting a Start condition.

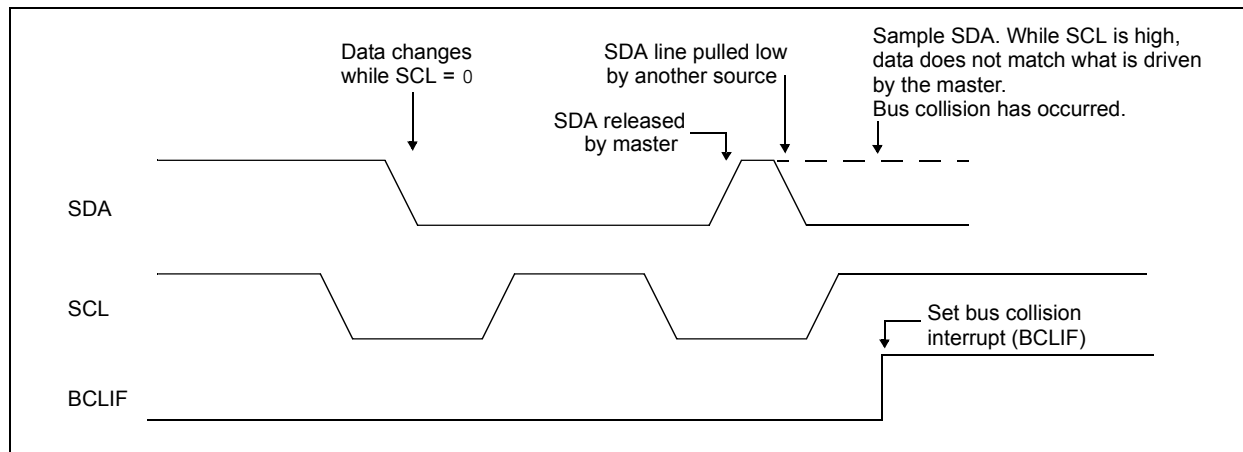
If a Start, Repeated Start, Stop or Acknowledge condition was in progress when the bus collision occurred, the condition is aborted, the SDA and SCL lines are deasserted and the respective control bits in the SSPCON2 register are cleared. When the user services the bus collision Interrupt Service Routine and if the I²C bus is free, the user can resume communication by asserting a Start condition.

The master will continue to monitor the SDA and SCL pins. If a Stop condition occurs, the SSPIF bit will be set.

A write to the SSPBUF will start the transmission of data at the first data bit, regardless of where the transmitter left off when the bus collision occurred.

In Multi-Master mode, the interrupt generation on the detection of Start and Stop conditions allows the determination of when the bus is free. Control of the I²C bus can be taken when the P bit is set in the SSPSTAT register, or the bus is Idle and the S and P bits are cleared.

FIGURE 21-32: BUS COLLISION TIMING FOR TRANSMIT AND ACKNOWLEDGE



21.8 Register Definitions: MSSP Control

REGISTER 21-3: SSPSTAT: SSP STATUS REGISTER

R/W-0/0	R/W-0/0	R-0/0	R-0/0	R-0/0	R-0/0	R-0/0	R-0/0
SMP	CKE	D/A	P	S	R/W	UA	BF
bit 7							bit 0

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7	SMP: SPI Data Input Sample bit <u>SPI Master mode:</u> 1 = Input data sampled at end of data output time 0 = Input data sampled at middle of data output time <u>SPI Slave mode:</u> SMP must be cleared when SPI is used in Slave mode <u>In I²C Master or Slave mode:</u> 1 = Slew rate control disabled for standard speed mode (100 kHz and 1 MHz) 0 = Slew rate control enabled for high speed mode (400 kHz)
bit 6	CKE: SPI Clock Edge Select bit (SPI mode only) <u>In SPI Master or Slave mode:</u> 1 = Transmit occurs on transition from active to Idle clock state 0 = Transmit occurs on transition from Idle to active clock state <u>In I²C mode only:</u> 1 = Enable input logic so that thresholds are compliant with SMBus specification 0 = Disable SMBus specific inputs
bit 5	D/A: Data/Address bit (I ² C mode only) 1 = Indicates that the last byte received or transmitted was data 0 = Indicates that the last byte received or transmitted was address
bit 4	P: Stop bit (I ² C mode only. This bit is cleared when the MSSP module is disabled, SSPEN is cleared.) 1 = Indicates that a Stop bit has been detected last (this bit is '0' on Reset) 0 = Stop bit was not detected last
bit 3	S: Start bit (I ² C mode only. This bit is cleared when the MSSP module is disabled, SSPEN is cleared.) 1 = Indicates that a Start bit has been detected last (this bit is '0' on Reset) 0 = Start bit was not detected last
bit 2	R/W: Read/Write bit information (I ² C mode only) This bit holds the R/W bit information following the last address match. This bit is only valid from the address match to the next Start bit, Stop bit, or not ACK bit. <u>In I²C Slave mode:</u> 1 = Read 0 = Write <u>In I²C Master mode:</u> 1 = Transmit is in progress 0 = Transmit is not in progress OR-ing this bit with SEN, RSEN, PEN, RCEN or ACKEN will indicate if the MSSP is in Idle mode.
bit 1	UA: Update Address bit (10-bit I ² C mode only) 1 = Indicates that the user needs to update the address in the SSPADD register 0 = Address does not need to be updated
bit 0	BF: Buffer Full Status bit <u>Receive (SPI and I²C modes):</u> 1 = Receive complete, SSPBUF is full 0 = Receive not complete, SSPBUF is empty <u>Transmit (I²C mode only):</u> 1 = Data transmit in progress (does not include the ACK and Stop bits), SSPBUF is full 0 = Data transmit complete (does not include the ACK and Stop bits), SSPBUF is empty

22.4 EUSART Baud Rate Generator (BRG)

The Baud Rate Generator (BRG) is an 8-bit or 16-bit timer that is dedicated to the support of both the asynchronous and synchronous EUSART operation. By default, the BRG operates in 8-bit mode. Setting the BRG16 bit of the BAUDCON register selects 16-bit mode.

The SPBRGH, SPBRGL register pair determines the period of the free running baud rate timer. In Asynchronous mode the multiplier of the baud rate period is determined by both the BRGH bit of the TXSTA register and the BRG16 bit of the BAUDCON register. In Synchronous mode, the BRGH bit is ignored.

Table 22-4 contains the formulas for determining the baud rate. Example 22-1 provides a sample calculation for determining the baud rate and baud rate error.

Typical baud rates and error values for various asynchronous modes have been computed for user's convenience and are shown in Table 22-4. It may be advantageous to use the high baud rate (BRGH = 1), or the 16-bit BRG (BRG16 = 1) to reduce the baud rate error. The 16-bit BRG mode is used to achieve slow baud rates for fast oscillator frequencies.

Writing a new value to the SPBRGH, SPBRGL register pair causes the BRG timer to be reset (or cleared). This ensures that the BRG does not wait for a timer overflow before outputting the new baud rate.

If the system clock is changed during an active receive operation, a receive error or data loss may result. To avoid this problem, check the status of the RCIDL bit to make sure that the receive operation is idle before changing the system clock.

EXAMPLE 22-1: CALCULATING BAUD RATE ERROR

For a device with FOSC of 16 MHz, desired baud rate of 9600, Asynchronous mode, 8-bit BRG:

$$\text{Desired Baud Rate} = \frac{F_{OSC}}{64(SPBRGH:SPBRGL + 1)}$$

Solving for SPBRGH:SPBRGL:

$$X = \frac{\frac{F_{OSC}}{\text{Desired Baud Rate}}}{64} - 1$$

$$= \frac{\frac{16000000}{9600}}{64} - 1$$

$$= [25.042] = 25$$

$$\text{Calculated Baud Rate} = \frac{16000000}{64(25 + 1)}$$

$$= 9615$$

$$\text{Error} = \frac{\text{Calc. Baud Rate} - \text{Desired Baud Rate}}{\text{Desired Baud Rate}}$$

$$= \frac{(9615 - 9600)}{9600} = 0.16\%$$

TABLE 22-4: BAUD RATE FORMULAS

Configuration Bits			BRG/EUSART Mode	Baud Rate Formula
SYNC	BRG16	BRGH		
0	0	0	8-bit/Asynchronous	$F_{osc}/[64 (n+1)]$
0	0	1	8-bit/Asynchronous	$F_{osc}/[16 (n+1)]$
0	1	0	16-bit/Asynchronous	
0	1	1	16-bit/Asynchronous	$F_{osc}/[4 (n+1)]$
1	0	x	8-bit/Synchronous	
1	1	x	16-bit/Synchronous	

Legend: x = Don't care, n = value of SPBRGH, SPBRGL register pair.

TABLE 22-3: SUMMARY OF REGISTERS ASSOCIATED WITH THE BAUD RATE GENERATOR

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
BAUDCON	ABDOVF	RCIDL	—	SCKP	BRG16	—	WUE	ABDEN	232
RCSTA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	231
SPBRGL	BRG<7:0>								233*
SPBRGH	BRG<15:8>								233*
TXSTA	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	230

Legend: — = unimplemented, read as '0'. Shaded cells are not used for the Baud Rate Generator.

* Page provides register information.

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22.5.2 SYNCHRONOUS SLAVE MODE

The following bits are used to configure the EUSART for Synchronous slave operation:

- SYNC = 1
- CSRC = 0
- SREN = 0 (for transmit); SREN = 1 (for receive)
- CREN = 0 (for transmit); CREN = 1 (for receive)
- SPEN = 1

Setting the SYNC bit of the TXSTA register configures the device for synchronous operation. Clearing the CSRC bit of the TXSTA register configures the device as a slave. Clearing the SREN and CREN bits of the RCSTA register ensures that the device is in the Transmit mode, otherwise the device will be configured to receive. Setting the SPEN bit of the RCSTA register enables the EUSART.

22.5.2.1 EUSART Synchronous Slave Transmit

The operation of the Synchronous Master and Slave modes are identical (see **Section 22.5.1.3 “Synchronous Master Transmission”**), except in the case of the Sleep mode.

If two words are written to the TXREG and then the SLEEP instruction is executed, the following will occur:

1. The first character will immediately transfer to the TSR register and transmit.
2. The second word will remain in TXREG register.
3. The TXIF bit will not be set.
4. After the first character has been shifted out of TSR, the TXREG register will transfer the second character to the TSR and the TXIF bit will now be set.
5. If the PEIE and TXIE bits are set, the interrupt will wake the device from Sleep and execute the next instruction. If the GIE bit is also set, the program will call the Interrupt Service Routine.

22.5.2.2 Synchronous Slave Transmission Setup:

1. Set the SYNC and SPEN bits and clear the CSRC bit.
2. Clear the ANSEL bit for the CK pin (if applicable).
3. Clear the CREN and SREN bits.
4. If interrupts are desired, set the TXIE bit of the PIE1 register and the GIE and PEIE bits of the INTCON register.
5. If 9-bit transmission is desired, set the TX9 bit.
6. Enable transmission by setting the TXEN bit.
7. If 9-bit transmission is selected, insert the Most Significant bit into the TX9D bit.
8. Start transmission by writing the Least Significant 8 bits to the TXREG register.

TABLE 22-7: SUMMARY OF REGISTERS ASSOCIATED WITH SYNCHRONOUS SLAVE TRANSMISSION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
BAUDCON	ABDOVF	RCIDL	—	SCKP	BRG16	—	WUE	ABDEN	232
INTCON	GIE	PEIE	TMR0IE	INTE	IOCIE	TMR0IF	INTF	IOCIF	74
PIE1	TMR1GIE	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	75
PIR1	TMR1GIF	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	77
RCSTA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	231
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	114
TXREG	EUSART Transmit Data Register								222*
TXSTA	CSRC	TX9	TXEN	SYNC	SENDER	BRGH	TRMT	TX9D	230

Legend: — = unimplemented, read as ‘0’. Shaded cells are not used for synchronous slave transmission.

* Page provides register information.

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25.7 Memory Programming Requirements

DC CHARACTERISTICS			Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$				
Param No.	Sym.	Characteristic	Min.	Typ†	Max.	Units	Conditions
Program Memory Programming Specifications							
D110	V _{IHH}	Voltage on $\overline{\text{MCLR}}/\text{VPP}$ pin	8.0	—	9.0	V	(Note 2)
D111	I _{DDP}	Supply Current during Programming	—	—	10	mA	
D112	V _{BE}	VDD for Bulk Erase	2.7	—	V _{DDMAX}	V	
D113	V _{PEW}	VDD for Write or Row Erase	V _{DDMIN}	—	V _{DDMAX}	V	
D114	I _{PPPGM}	Current on $\overline{\text{MCLR}}/\text{VPP}$ during Erase/Write	—	1.0	—	mA	
D115	I _{DDPGM}	Current on VDD during Erase/Write	—	5.0	—	mA	
Program Flash Memory							
D121	EP	Cell Endurance	10K	—	—	E/W	-40°C to +85°C (Note 1)
D122	V _{PRW}	VDD for Read/Write	V _{DDMIN}	—	V _{DDMAX}	V	
D123	T _{IW}	Self-timed Write Cycle Time	—	2	2.5	ms	Provided no other specifications are violated
D124	T _{RET}	Characteristic Retention	—	40	—	Year	
D125	E _{HEFC}	High-Endurance Flash Cell	100K	—	—	E/W	

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Self-write and Block Erase.

Note 2: Required only if single-supply programming is disabled.

TABLE 25-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, POWER-UP TIMER AND BROWN-OUT RESET PARAMETERS

Standard Operating Conditions (unless otherwise stated) Operating Temperature $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$							
Param No.	Sym.	Characteristic	Min.	Typ†	Max.	Units	Conditions
30	TMCL	MCLR Pulse Width (low)	2	—	—	μs	
31	TWDTLP	Low-Power Watchdog Timer Time-out Period	10	16	27	ms	$V_{DD} = 3.3\text{V}-5\text{V}$, 1:512 Prescaler used
32	TOST	Oscillator Start-up Timer Period ⁽¹⁾	—	1024	—	T_{osc}	
33*	TPWRT	Power-up Timer Period, $\overline{\text{PWRTE}} = 0$	40	65	140	ms	
34*	TIOZ	I/O high-impedance from MCLR Low or Watchdog Timer Reset	—	—	2.0	μs	
35	VBOR	Brown-out Reset Voltage ⁽²⁾	2.55	2.70	2.85	V	BORV = 0
			2.35	2.45	2.58	V	BORV = 1 (PIC16F1516/7/8/9)
			1.80	1.90	2.00	V	BORV = 1 (PIC16LF1516/7/8/9)
36*	VHYST	Brown-out Reset Hysteresis	0	25	60	mV	-40°C to $+85^{\circ}\text{C}$
37*	TBORDC	Brown-out Reset DC Response Time	1	3	35	μs	$V_{DD} \leq V_{BOR}$
38	VLPBOR	Low-Power Brown-out Reset Voltage	1.8	2.1	2.5	V	$\overline{\text{LPBOR}} = 0$

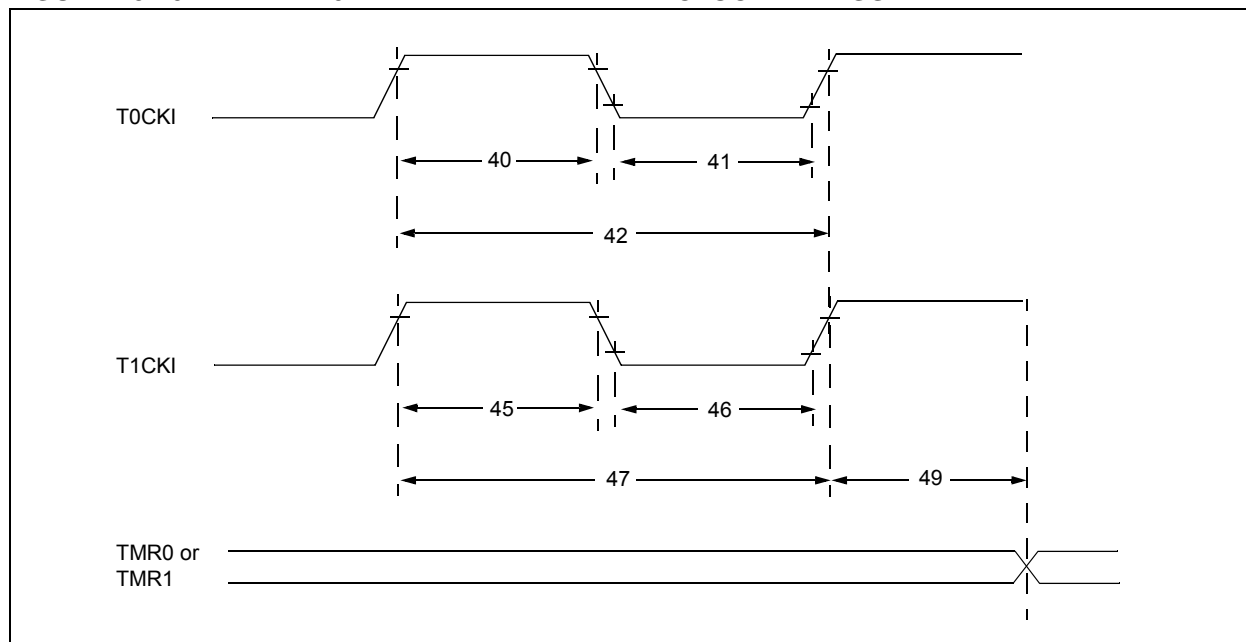
* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: By design, the Oscillator Start-up Timer (OST) counts the first 1024 cycles, independent of frequency.

2: To ensure these voltage tolerances, V_{DD} and V_{SS} must be capacitively decoupled as close to the device as possible. 0.1 μF and 0.01 μF values in parallel are recommended.

FIGURE 25-10: TIMER0 AND TIMER1 EXTERNAL CLOCK TIMINGS



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TABLE 25-7: ANALOG-TO-DIGITAL CONVERTER (ADC) CHARACTERISTICS^(1,2,3)

Standard Operating Conditions (unless otherwise stated)							
Operating temperature Tested at +25°C							
Param No.	Sym.	Characteristic	Min.	Typ†	Max.	Units	Conditions
AD01	NR	Resolution	—	—	10	bit	
AD02	EIL	Integral Error	—	±1	±1.7	LSb	VREF = 3.0V
AD03	EDL	Differential Error	—	±1	±1	LSb	No missing codes VREF = 3.0V
AD04	EOFF	Offset Error	—	±1	±2.5	LSb	VREF = 3.0V
AD05	EGN	Gain Error	—	±1	±2.0	LSb	VREF = 3.0V
AD06	VREF	Reference Voltage ⁽⁴⁾	1.8	—	VDD	V	VREF = (VREF+ minus VREF-)
AD07	VAIN	Full-Scale Range	VSS	—	VREF	V	
AD08	ZAIN	Recommended Impedance of Analog Voltage Source	—	—	10	kΩ	Can go higher if external 0.01μF capacitor is present on input pin.

* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Total Absolute Error includes integral, differential, offset and gain errors.

2: The ADC conversion result never decreases with an increase in the input voltage and has no missing codes.

3: ADC VREF is from external VREF, VDD pin or FVR, whichever is selected as reference input.

4: ADC Reference Voltage (Ref+) is the selected reference input, VREF+ pin, VDD pin or the FVR selected as the reference input, the FVR Buffer1 output selection must be 2.048V or 4.096V, (ADFVR<1:0> = 1x).

TABLE 25-8: ADC CONVERSION REQUIREMENTS

Standard Operating Conditions (unless otherwise stated)							
Operating temperature -40°C ≤ TA ≤ +125°C							
Param No.	Sym.	Characteristic	Min.	Typ†	Max.	Units	Conditions
AD130*	TAD	ADC Clock Period	1.0	—	9.0	μs	FOSC-based
		FRC Oscillator Period	1.0	2.5	6.0	μs	ADCS<1:0> = 11 (FRC Oscillator mode)
AD131	Tcnv	Conversion Time (not including Acquisition Time) ⁽¹⁾	—	11	—	TAD	Set GO/DONE bit to conversion complete
AD132*	TACQ	Acquisition Time	—	5.0	—	μs	
AD133*	THCD	Holding Capacitor Disconnect	—	0.5*TAD + 40 ns (0.5*TAD + 40 ns) to (0.5*TAD + 40 ns)	—		ADCS<2:0> = X11 (FOSC-based)
			—		—		ADCS<2:0> = X11 (ADC FRC mode)

* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: The ADRES register may be read on the following Tcy cycle.

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FIGURE 26-5: I_{DD} TYPICAL, XT AND EXTRC OSCILLATOR, PIC16F1516/7/8/9 ONLY

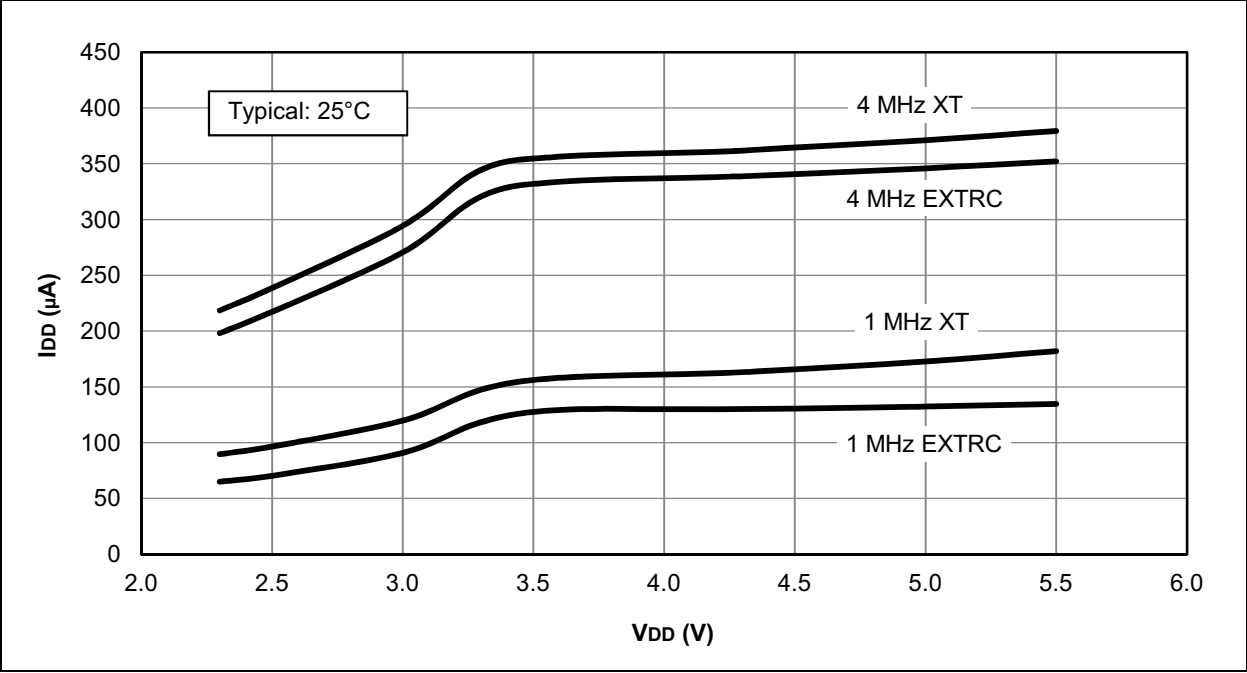


FIGURE 26-6: I_{DD} MAXIMUM, XT AND EXTRC OSCILLATOR, PIC16F1516/7/8/9 ONLY

